

2SJ242(L), 2SJ242(S)

Silicon P Channel MOS FET

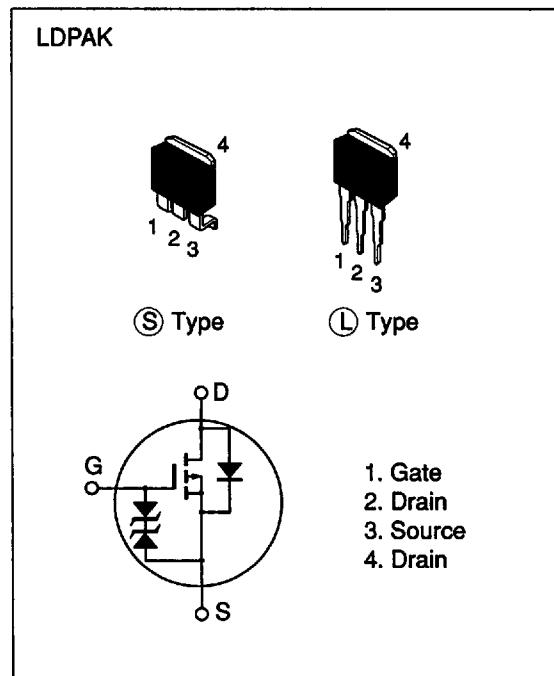
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Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device --- can be driven from 5 V source
- Suitable for DC – DC convertor, motor drive, power switch, solenoid drive

**Table 1 Absolute Maximum Ratings (Ta = 25°C)**

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	-60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	-30	A
Drain peak current	I _{D(pulse)*}	-120	A
Body-drain diode reverse drain current	I _{DR}	-30	A
Channel dissipation	P _{ch} **	75	W
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

* PW ≤ 10 µs, duty cycle ≤ 1 %

** Value at T_c = 25 °C

Table 2 Electrical Characteristics ($T_a = 25^\circ\text{C}$)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	-60	—	—	V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(\text{BR})\text{GSS}}$	± 20	—	—	V	$I_G = \pm 100 \mu\text{A}, V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	-250	μA	$V_{DS} = -50 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(\text{off})}$	-1.0	—	-2.0	V	$I_D = -1 \text{ mA}$ $V_{DS} = -10 \text{ V}$
Static drain to source on state resistance	$R_{DS(\text{on})}$	—	0.045	0.06	Ω	$I_D = -15 \text{ A}$ $V_{GS} = -10 \text{ V}^*$
		—	0.07	0.09		$I_D = -15 \text{ A}$ $V_{GS} = -4 \text{ V}^*$
Forward transfer admittance	$ y_{fs} $	12	20	—	S	$I_D = -15 \text{ A}$ $V_{DS} = -10 \text{ V}^*$
Input capacitance	C_{iss}	—	2400	—	pF	$V_{DS} = -10 \text{ V}$
Output capacitance	C_{oss}	—	1300	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	340	—	pF	$f = 1 \text{ MHz}$
Turn-on delay time	$t_{d(\text{on})}$	—	20	—	ns	$I_D = -15 \text{ A}$
Rise time	t_r	—	175	—	ns	$V_{GS} = -10 \text{ V}$
Turn-off delay time	$t_{d(\text{off})}$	—	460	—	ns	$R_L = 2 \Omega$
Fall time	t_f	—	320	—	ns	
Body-drain diode forward voltage	V_{DF}	—	1.25	—	V	$I_F = -30 \text{ A}, V_{GS} = 0$
Body-drain diode reverse recovery time	t_{rr}	—	240	—	ns	$I_F = -30 \text{ A}, V_{GS} = 0,$ $dI_F/dt = 50 \text{ A}/\mu\text{s}$

* Pulse Test

See characteristic curves of 2SJ215.

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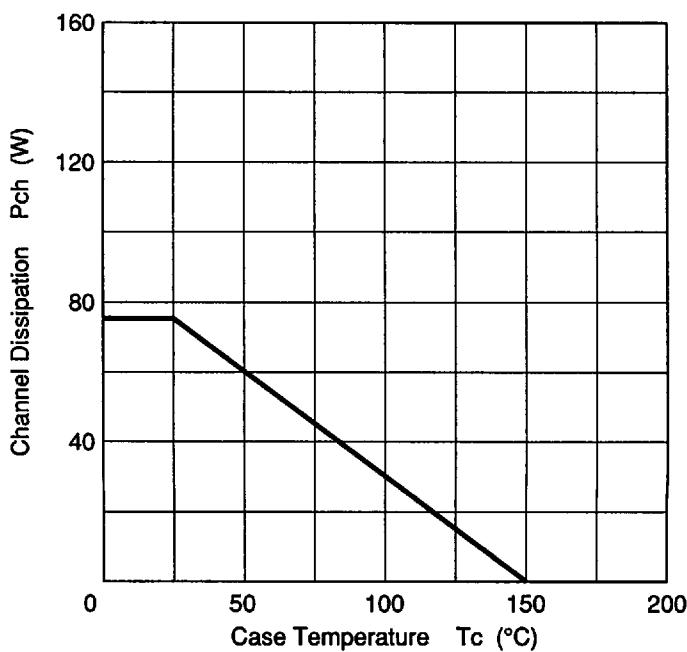


Figure 1 Power vs. Temperature Derating

Package Dimensions

Unit: mm

LDPAK

